

	A	B	C	REMARK N-9T		REMARK LCP	
				(有碼)	(無碼)	(有碼)	(無碼)
10	10.16	20.35	18.00	⊕	⊕		
14	15.24	25.43	23.08	⊕			
16	17.78	27.97	25.62	⊕			
20	22.86	33.05	30.70	⊕	⊕		
26	30.48	40.67	38.32	⊕			
34	40.64	50.83	48.48	⊕			
40	48.26	58.45	56.10	⊕	⊕	⊕	
44	53.34	63.53	61.18		⊕		

SPHS-XXS-X-X-*-*-*

Number of Contacts
Straight
Contact Plating

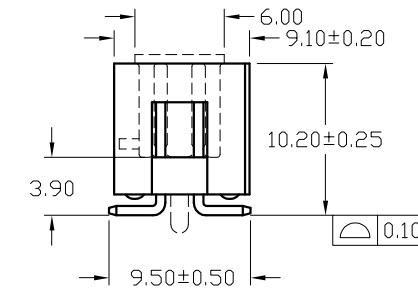
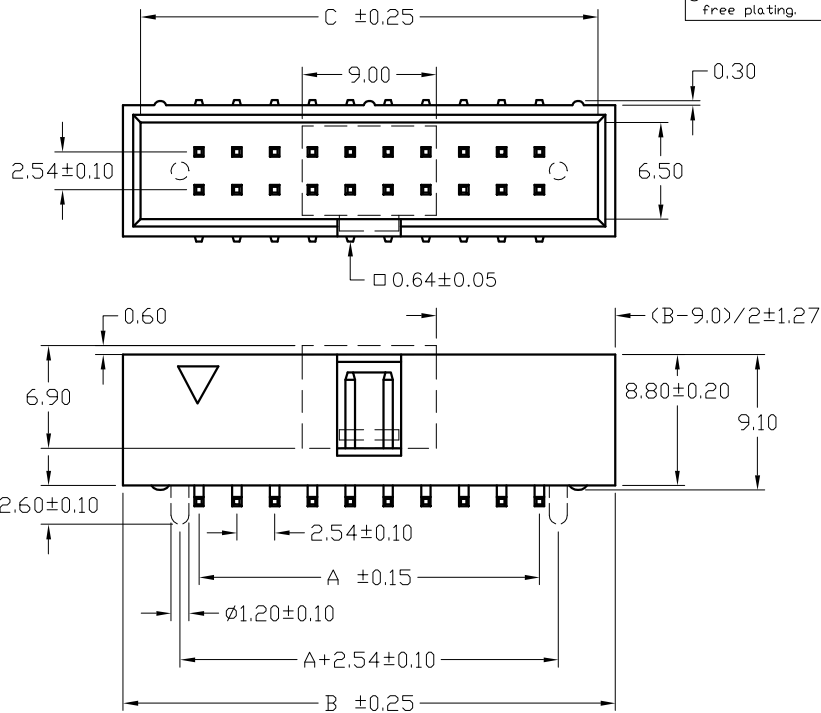
Definition	Code
◎ Tin plated:	A
◎ Gold plated:	
flash B 15μ" F	
10μ" E 30μ" J	
◎ Duplex plating:	
flash K 15μ" P	
10μ" N 30μ" U	
◎ Standard: B	
◎ Prefix "V" means lead free plating.	

NULL:TUBE(W/O PAD)
P:PAD+TUBE
R:PAD+REEL
NULL:Nylon-9T ▲
E:LCP
NULL:BLACK
D:WHITE
S:BLUE
0:W/O Locating peg
1:With Locating peg

SPECIFICATIONS

Current Rating: 3 Amps
Insulator resistance: 5000 Megohms Min.
Dielectric withstanding: AC 500 V
Operating Temperature: -40° ~ +105°C
Contact Material: Copper Alloy
Insulator Material: High Temperature Thermoplastic,UL 94V-0

Finish: Tin,Gold or Duplex plated
◎ Note:
Duplex plating: gold plated on contact area, Tin on solder area



Recommended PCB Layout (PCB TOLERANCE ±0.05)

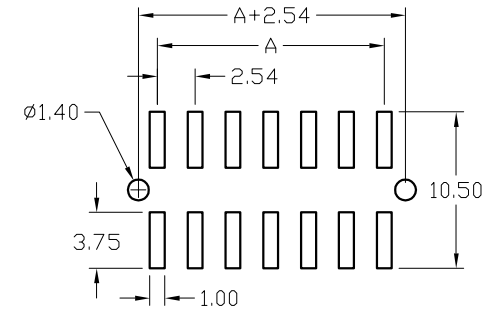


Diagram	Molding description	Rev.	ECN Number	Description	Drawn	Date
○	mass production & assemble mold	7	ECR-4C0147	新增材質及顏色選項	洪銀雯	01/19 05'
⊕	sample & assemble mold	8	EC2-530138	新增 44 PIN無導	陳美竹	03/09 05'
⊕	mass production & fix mold	9	ECR-5C0054	原Nylon-6T塑膠起泡 變更為Nylon-9T材質	陳賜農	01/13'06
⊕	sample & fix mold					



GENERAL TOLERANCE		SCALE	ORIGINAL DRAWN	DATE	DWG. NO.	TITLE	REV.		
XX. ± 0.50	XXX. ±	2=1	邱若婷	24-11-03'	3-24			2.54X2.54mm BOX HEADER (成品規格圖)	9
X. ± 0.30	.XXX ±	UNIT	林錫錦	01/13'06	F:\NEW\CDWG\PHS\PHSMOE.DWG				
XX ± 0.25	X. ± 4'	SIZE	林錫錦	01/13'06	PARTS NO.		SHEET		
.XX ± 0.20	.X ± 4'	A4	APPROVE		SPHS-XXS-X-X-*-*-*		1/1		